L Number	Hits	Search Text	DB	Time stamp
1	1595	(257/775,781,768,769).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 14:20
2	20	((257/775,781,768,769).CCLS.) and (first and second) with gold with (coat$3 film)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 14:21
3	18	(two second) with gold with (coat$3 film) same (bond near pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 14:23
4	4	(two second) with (gold au) with (coat$3 film) same (bond near pad) not ((two second) with gold with (coat$3 film) same (bond near pad))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 14:24
5	1404	(two second) with (gold au) with (coat$3 film)	JPO; DERWENT	2004/07/20 14:24
6	105	(two second) with (gold au) with (coat$3 film) and pad	JPO; DERWENT	2004/07/20 14:24
-	2	("20010002734").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 16:44
-	18	(("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699")).PN. or (2001/0002726).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 12:00
-	162	(copper cu al aluminum) near3 (pad) with (gold au) near2 (coat$3 film)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 07:42
-	80	((copper cu al aluminum) near3 (pad) with (gold au) near2 (coat$3 film)) and solder$3 and wir$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 08:03
-	3	("5909633").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 09:07
-	2	jp-11067957-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 09:07
-	18	(("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699")).PN. or (2001/0002726).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 12:00

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-	9	(US-4788767-$ or US-6169330-$ or US-5311404-$ or US-5380679-$ or US-5663598-$ or US-5909633-$).did. or (US-20030102548-$).did. or (JP-10163241-$ or JP-11067957-$).did.	USPAT; US-PGPUB; DERWENT	2004/07/20 12:00
-	23	(((("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699")).PN. or (2001/0002726).CCLS.) ((US-4788767-$ or US-6169330-$ or US-5311404-$ or US-5380679-$ or US-5663598-$ or US-5909633-$).did. or (US-20030102548-$).did. or (JP-10163241-$ or JP-11067957-$).did.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 12:00
-	557	bond near pad with ((copper cu) and (al aluminum))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 12:01
-	1	((((("5380679") or ("4692997") or ("5311404") or ("6169330") or ("5663598") or ("6127715") or ("4229248") or ("6090699")).PN. or (2001/0002726).CCLS.) ((US-4788767-$ or US-6169330-$ or US-5311404-$ or US-5380679-$ or US-5663598-$ or US-5909633-$).did. or (US-20030102548-$).did. or (JP-10163241-$ or JP-11067957-$).did.)) and (bond near pad with ((copper cu) and (al aluminum)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 12:01
-	435	bond near pad with ((copper cu) with (al aluminum))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/20 12:02